

N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)
100	0.018 at V _{GS} = 10 V	65 ^a

FEATURES

- DT-Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % Rg Tested

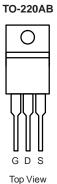
APPLICATIONS

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• Isolated DC/DC Converters







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current ($T_1 = 175 \text{ °C}$)	T _C = 25 °C	I _D	58 ^a		
Continuous Drain Current (1j = 175 C)	T _C = 125 °C	^{ID}	31 ^a	А	
Pulsed Drain Current		I _{DM}	195		
Avalanche Current	L = 0.1 mH	I _{AS}	31		
Single Pulse Avalanche Energy ^b	L = 0.1 1111	E _{AS}	60	mJ	
Marian Diana Diana dia di	T _C = 25 °C	Р	355 ^c	10/	
Maximum Power Dissipation ^b	T _A = 25 °C ^d	- P _D -	3.35	W	
Operating Junction and Storage Temperature Ra	inge	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RA	TINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	0/11

Notes:

a. Package limited.

- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	μA	
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А	
		V _{GS} = 10 V, I _D = 30 A		0.018			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C			0.023	Ω	
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.037		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}			3200		pF	
Output Capacitance	C _{oss}	-		410			
Reverse Transfer Capacitance	C _{rss}			210			
Total Gate Charge ^c	Qg	g	90	130			
Gate-Source Charge ^c	Q _{gs}			23		nC	
Gate-Drain Charge ^c	Q _{gd}			34			
Gate Resistance	R _g		0.5	1.3	3.1	Ω	
Turn-On Delay Time ^c	t _{d(on)}			24	35		
Rise Time ^c	t _r	V _{DD} = 100 V, R _L = 1.5 Ω		220	330	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 58$ A, V_{GEN} = 10 V, R_g = 2.5		45	70		
Fall Time ^c	t _f	Ω		200	300		
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b					
Continuous Current	۱ _S				65	A	
Pulsed Current	I _{SM}				195		
Forward Voltage ^a	V _{SD}	I _F = 58 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 30 A, di/dt = 100 A/µs		8	12	A	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

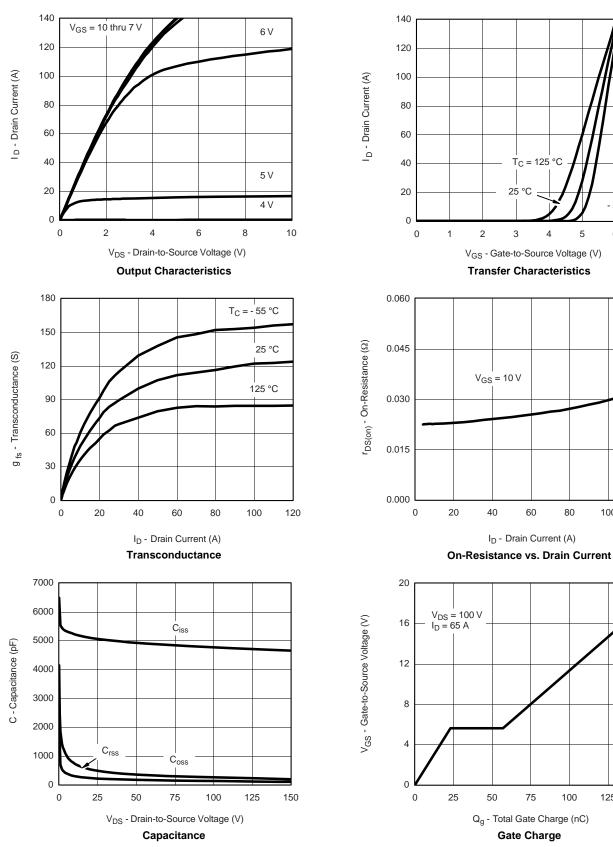


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- 55 °C

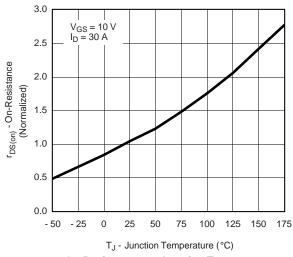




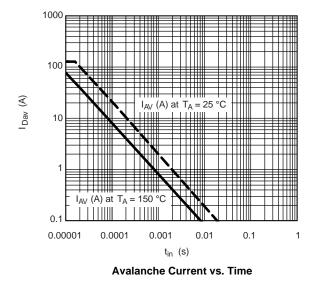
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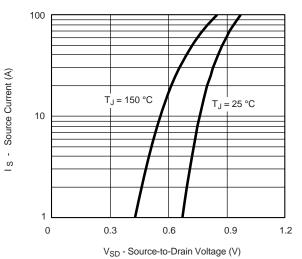
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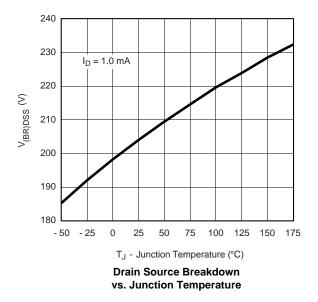


On-Resistance vs. Junction Temperature





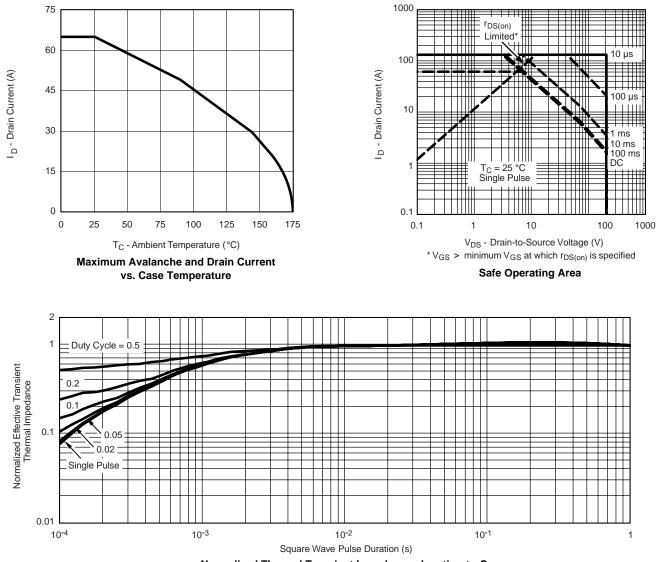
Source-Drain Diode Forward Voltage





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THERMAL RATINGS

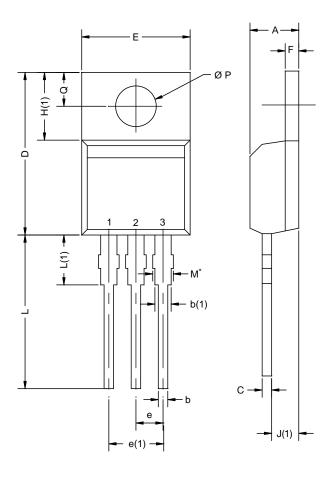


Normalized Thermal Transient Impedance, Junction-to-Case



Package Information www.din-tek.jp

TO-220AB



MIN.	MAX.	MIN.	MAX.
4.25	4.65	0.167	0.183
0.69	1.01	0.027	0.040
1.20	1.73	0.047	0.068
0.36	0.61	0.014	0.024
14.85	15.49	0.585	0.610
10.04	10.51	0.395	0.414
2.41	2.67	0.095	0.105
4.88	5.28	0.192	0.208
1.14	1.40	0.045	0.055
6.09	6.48	0.240	0.255
2.41	2.92	0.095	0.115
13.35	14.02	0.526	0.552
3.32	3.82	0.131	0.150
3.54	3.94	0.139	0.155
2.60	3.00	0.102	0.118
	4.25 0.69 1.20 0.36 14.85 10.04 2.41 4.88 1.14 6.09 2.41 13.35 3.32 3.54 2.60	4.25 4.65 0.69 1.01 1.20 1.73 0.36 0.61 14.85 15.49 10.04 10.51 2.41 2.67 4.88 5.28 1.14 1.40 6.09 6.48 2.41 2.92 13.35 14.02 3.32 3.82 3.54 3.94	4.254.650.1670.691.010.0271.201.730.0470.360.610.01414.8515.490.58510.0410.510.3952.412.670.0954.885.280.1921.141.400.0456.096.480.2402.412.920.09513.3514.020.5263.323.820.1313.543.940.1392.603.000.102

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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